

July 2010

DFB2005 - DFB20100 Glass Passivated Bridge Rectifiers

Features

- UL certificate # E326243
- · Glass passivated junction
- · Ideal for printed circuit board
- · Reliable low cost construction
- · Plastic material has Underwriters Laboratory Flammability Classification 94V-0
- · Surge overload rating to 250 amperes peak
- High case dielectric strength of 2000 V_{RMS}
- · Isolated voltage from case to lead over 2500 volts



TS-6P

Absolute Maximum Ratings* T_A = 25°C unless otherwise noted

Symbol	Parameter	Value							
		DFB20 05***	DFB20 10***	DFB20 20***	DFB20 40***	DFB20 60	DFB20 80***	DFB20 100***	Units
V _{RRM}	Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000	V
V _{RMS}	Maximum RMS Voltage	35	70	140	280	420	560	700	V
V _{DC}	Maximum DC Blocking Voltage	50	100	200	400	600	800	1000	V
I _(AV)	Maximum Average Forward Rectified Current				20				Α
I _{FSM}	Peak Forward Surge Current (8.3mS Single Half-wave)	250			Α				
$R_{\theta JC}$	Typical Thermal Resistance**	0.8			°C/W				
T _J	Operating Temperature Range	-55 to +150			°C				
T _{STG}	Storage Temperature Range	-55 to +150			°C				

^{*} Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Electrical Characteristics T_A = 25°C unless otherwise specified

Symbol	Parameter	Test condition	Value	Unit
V _F	Maximum Instantaneous Forward Voltage	@ 10A @ 20A	1.0 1.1	V
I _R	Maximum DC Reverse Current at Rated DC Blocking Voltage	@ T _A = 25°C @ T _A = 125°C	10 500	μА
l ² t	Rating for fusing (t < 8.3mS)		259	A ² S
Cj	Typical Junction Capacitance per leg*		140	pF

^{*} Measured at 1MHz and applied Reverse bias of 4.0V DC.

^{**} Device mounted on 4" x 5" x 0.25" Al-plate heat sink.

^{***} In development. Please contact Fairchild Semiconductor for more information.

Typical Performance Characteristics

Figure 1. Maximum Derating Curve for Output Current

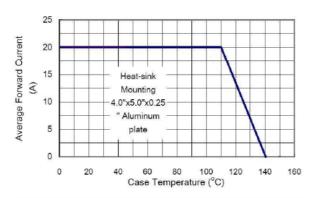


Figure 2. Maximum Forward Surge Current per Leg

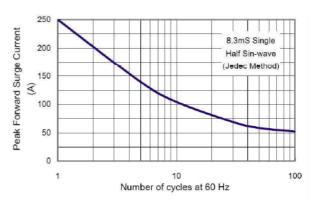


Figure 3. Typical Reverse Characteristics per Leg

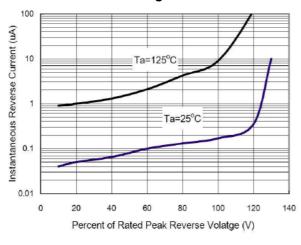


Figure 4. Typical Forward Characteristics per Leg

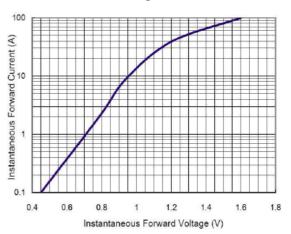
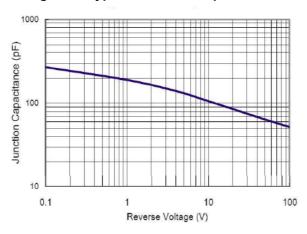
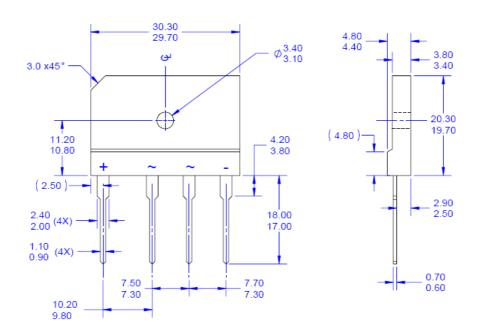


Figure 5. Typical Junction Capacitance



Physical Dimensions

TS-6P



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Dimensions in Millimeters





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Definition of Terms					
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